Erratum to: Aspects of Integrating Functional Electroceramic Material in Multilayer Thin Films for Image Sensing: Modeling and Experiment

M.A. MATIN,^{1,4,5} K. OISHI,² A. KATSUTA,² D. AKAI,² K. SAWADA,^{2,3}
and M. ISHIDA^{2,3}

1.—Glass and Ceramic Engineering, Bangladesh University of Engineering and Technology, Dhaka 1000, Bangladesh. 2.—Electrical and Electronic Information Engineering, Toyohashi University of Technology, Toyohashi, Aichi 441-8580, Japan. 3.—Electronics-Inspired Interdisciplinary Research Institute (EIIRIS), Toyohashi University of Technology, Toyohashi 441-8580, Japan. 4.—e-mail: mmatin@gce.buet.ac.bd. 5.—e-mail: martin.md.a@gmail.com

Erratum to: Journal of ELECTRONIC MATERIALS DOI 10.1007/s11664-015-3631-x

On the second page of the original article, in the Residual Stresses section directly below Eq. 1, the corrected text is as follows:

where σ_{ij} is the second Piola-Kirchhoff stress tensor, ε_{kl} the Lagrangian strain tensor, C_{ijkl} is elastic tensor of the solid, α_{ij} denotes the thermal expansion tensor and $\Delta\Theta = \Theta - \Theta_0$ represents the temperature difference (where Θ_0 is the stress free temperature state and Θ is the final temperature state).